Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	(imprinted with particle with electron with hole and polymer and transparent with polymerizable and transport and substrate).clm.	US-PGPUB	OR	OFF	2006/07/23 13:13

	·····		1			
S78	4	("6517995" "6946410").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/23 10:57
S79	41	("6517995" "6946410")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/23 10:46
S80	452	977/742,842-845.CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/23 10:47
S83	330	257/E51.04.CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/23 10:48
S84	750	S80 OR S83	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/23 10:49
S86	467	S84 and electron	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/23 10:49
S88	114	S84 and (electron and hole)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/23 13:09
S90	4	("20020117659" "20020130311" "6123819" "6438025").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/07/23 10:59
S91	1	("6149775").PN. OR ("6827823"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/07/23 11:00

S92	8	("4589196" "5207263"	US-PGPUB;	OR	OFF	2006/07/23 11:01
		"5314569" "5362972" "5814290"	USPAT;			
		"6274489" "6329256"	USOCR			
		"6451113").PN.				

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	(imprinted with particle with electron with hole and polymer and transparent with polymerizable and transport and substrate).clm.	US-PGPUB	OR	OFF	2006/07/23 13:13
L2	0	10/699440	US-PGPUB	OR	OFF	2006/07/23 13:14
S40	921	imprint\$3 with nano\$10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/23 10:32
S41	156	imprint\$3 with nano\$10 same electron	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 09:02
S42	22	imprint\$3 with nano\$10 same electron same hole	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 09:05
S43	520	imprint\$3 with nano\$10 same (substrate wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 09:06
S44	0	imprint\$3 with nano\$10 same (substrate wafer) with mwnt	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 09:19
S45	0	imprint\$3 with nano\$10 same mwnt	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 09:07
S46	0	imprint\$3 with nano\$10 same 'mwnt'	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 09:07

S47	0	imprint\$3 with nano\$10 same multiwalled	US-PGPUB; USPAT; USOCR; EPO; JPO;	OR	ON	2006/04/15 09:07
			DERWENT; IBM_TDB			
S48	0	imprint\$3 with nano\$10 same multiwall\$2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 09:08
S49	21	imprint\$3 with nano\$10 same carbon near3 nanotube	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 14:01
S50	848	(imprint\$3 with nano\$10) and (substrate wafer wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 09:21
S51	87	S50 and carbon	USPAT	OR	OFF	2006/04/15 09:28
S52	61	S51 and polymer	USPAT	OR	OFF	2006/04/15 09:29
S53	25	S52 and transparent	USPAT	OR	OFF	2006/04/15 09:42
S54	24	"6517995"	USPAT	OR	OFF	2006/04/15 09:42
S55	1	10/709999	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 15:33
S56	276	(bond with pad and dielectric and first mask and second adj mask and contiguous and interconnct adj line).clm.	US-PGPUB	OR	ON	2006/04/15 15:35
S57	276	(bond with pad and dielectric and first mask and second adj mask and contiguous and interconnct adj line and hole).clm.	US-PGPUB	OR	ON	2006/04/15 15:35
S58	276	(bond with pad and dielectric and first mask and second adj mask and contiguous and interconnct adj line and hole and contiguous adj trench).clm.	US-PGPUB	OR	ON	2006/04/15 15:36